

Solid State Relay OCMOS FET

<u>PS7241-2A</u>

8-PIN SOP, 400V BREAK DOWN VOLTAGE NORMALLY OPEN TYPE 2-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

The PS7241-2A is a solid state relay containing GaAs LEDs on the light emitting side (input side) and normally open (N.O.) contact MOS FETs on the output side.

It is suitable for analog signal control because of their low offset and high linearity.

FEATURES

- 2 channel type (1 a + 1 a output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small and thin package (8-pin SOP, Height = 2.1 mm)
- Low offset voltage
- Ordering number of taping product : PS7241-2A-F3, F4: 1 500 pcs/reel
- <R> Pb-Free product
 - · Safety standards
 - UL approved: File No. E72422
 - BSI approved: No. 8241/8242
 - CSA approved: No. CA 101391

APPLICATIONS

- · Exchange equipment
- · Measurement equipment
- FA/OA equipment

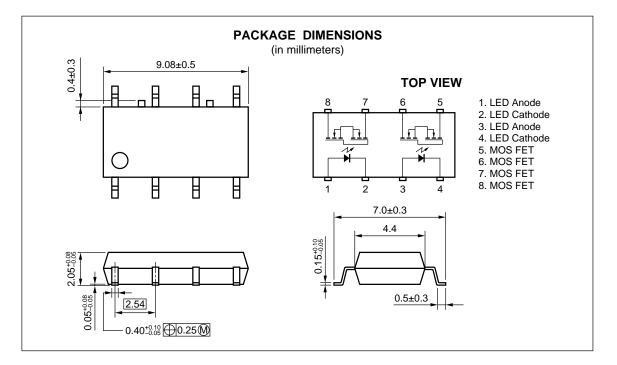
The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

Document No. PN10304EJ02V0DS (2nd edition) Date Published August 2006 NS CP(K)

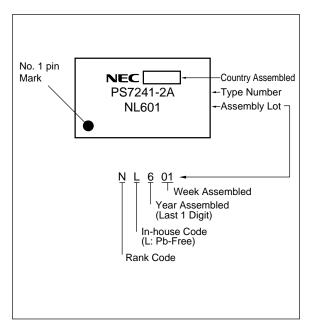
The mark <R> shows major revised points.

© NEC Electronics Corporation 1998, 2006

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7241-2A	PS7241-2A-A	Pb-Free	Magazine case 45 pcs	Standard products	PS7241-2A
PS7241-2A-F3	PS7241-2A-F3-A		Embossed Tape 1 500 pcs/reel	(UL, BSI, CSA	
PS7241-2A-F4	PS7241-2A-F4-A			approved)	

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lf	50	mA/ch
	Reverse Voltage	VR	5	V
	Power Dissipation	P⊳	50	mW/ch
	Peak Forward Current *1	IFP	1	A/ch
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	١L	120	mA/ch
	Pulse Load Current ^{*2} (AC/DC Connection)	Ilp	200	mA/ch
	Power Dissipation	PD	180	mW/ch
Isolation Voltage *3		BV	1 500	Vr.m.s.
Total Power Dissipation		Ρτ	460	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

*1 PW = 100 *µ*s, Duty Cycle = 1%

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-4 shorted together, 5-8 shorted together.

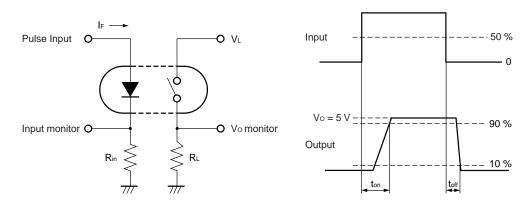
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lf	2	10	20	mA/ch
LED Off Voltage	VF	0		0.5	V

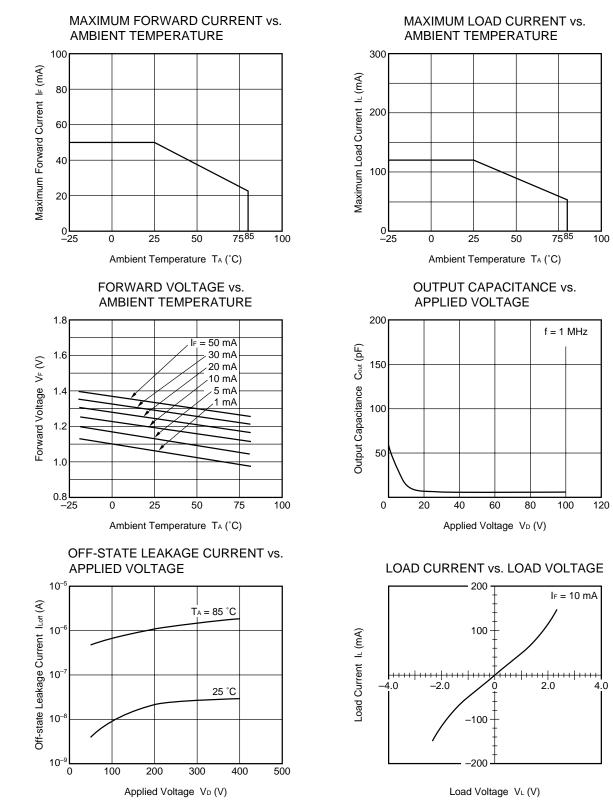
ELECTRICAL CHARACTERISTICS (TA = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	V _R = 5 V			5	μA
MOS FET	Off-state Leakage Current	Loff	V _D = 400 V		0.03	1.0	μA
	Output Capacitance	Cout	V _D = 0 V, f = 1.0 MHz		65		pF/ch
Coupled	LED On-state Current	IFon	l∟ = 120 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		21	30	Ω
		Ron2	I_{F} = 10 mA, I_{L} = 120 mA, $t \leq$ 10 ms		16	25	
	Turn-on Time ^{*1, 2}	ton	I_{F} = 10 mA, Vo = 5 V, R _L = 500 Ω ,		0.2	1.0	ms
	Turn-off Time ^{*1, 2}	toff	$PW \ge 10 ms$		0.02	0.2	
	Isolation Resistance	Rŀo	VI-0 = 1.0 kVDC	10 ⁹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.4		pF/ch

*1 Test Circuit for Switching Time



<R> *2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms. Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.



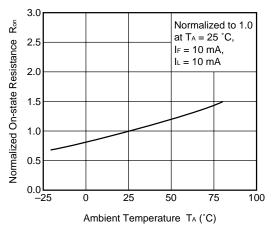
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

Remark The graphs indicate nominal characteristics.

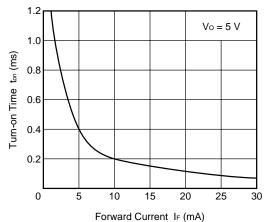
Data Sheet PN10304EJ02V0DS

5

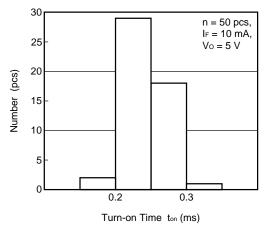
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



TURN-ON TIME vs. FORWARD CURRENT

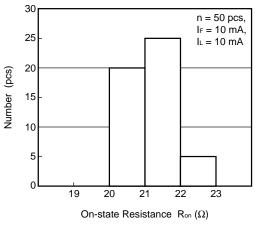


TURN-ON TIME DISTRIBUTION

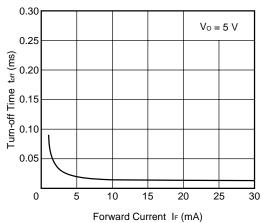


Remark The graphs indicate nominal characteristics.

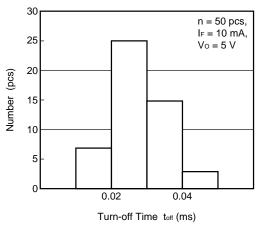
ON-STATE RESISTANCE DISTRIBUTION

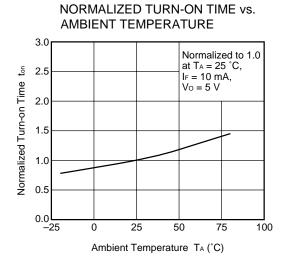


TURN-OFF TIME vs. FORWARD CURRENT



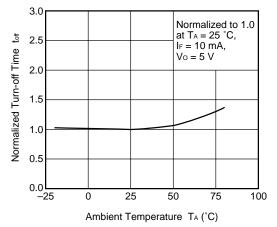
TURN-OFF TIME DISTRIBUTION



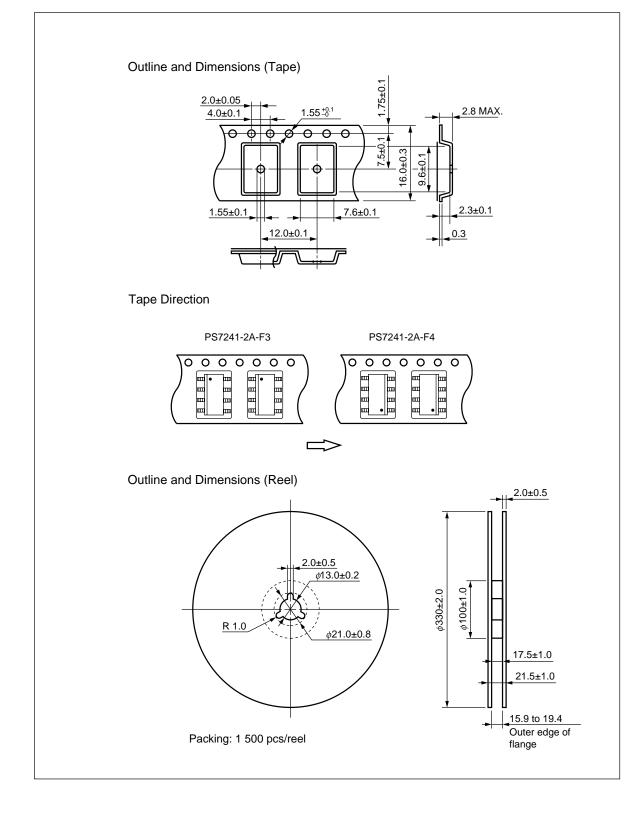


Remark The graphs indicate nominal characteristics.





TAPING SPECIFICATIONS (in millimeters)



RECOMMENDED SOLDERING CONDITIONS

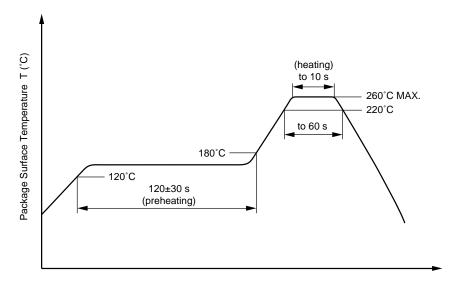
(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 	260°C or below (molten solder temperature)
• Time	10 seconds or less
 Preheating conditions 	120°C or below (package surface temperature)
 Number of times 	One
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

<R> (3) Soldering by soldering iron

Peak temperature (lead part temperature)	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

content of 0.2 Wt% is recommended.)

(b) Please be sure that the temperature of the package would not be heated over 100° C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

- The information in this document is current as of August, 2006. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.
- No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Electronics. NEC Electronics assumes no responsibility for any errors that may appear in this document.
- NEC Electronics does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC Electronics products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Electronics or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software and information in the design of a customer's equipment shall be done under the full responsibility of the customer. NEC Electronics assumes no responsibility for any losses incurred by customers or third parties arising from the use of these circuits, software and information.
- While NEC Electronics endeavors to enhance the quality, reliability and safety of NEC Electronics products, customers agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize risks of damage to property or injury (including death) to persons arising from defects in NEC Electronics products, customers must incorporate sufficient safety measures in their design, such as redundancy, fire-containment and anti-failure features.
- NEC Electronics products are classified into the following three quality grades: "Standard", "Special" and "Specific".

The "Specific" quality grade applies only to NEC Electronics products developed based on a customerdesignated "quality assurance program" for a specific application. The recommended applications of an NEC Electronics product depend on its quality grade, as indicated below. Customers must check the quality grade of each NEC Electronics product before using it in a particular application.

- "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots.
- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
- "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

M8E 02.11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.

NEC Compound Semiconductor Devices Hong Kong Limited E-mail: contact@ncsd-hk.necel.com Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309 Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859 Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209 NEC Electronics (Europe) GmbH http://www.eu.necel.com/ TEL: +49-211-6503-0 FAX: +49-211-6503-1327 California Eastern Laboratories, Inc. http://www.cel.com/ TEL: +1-408-988-3500 FAX: +1-408-988-0279 **Compound Semiconductor Devices Division NEC Electronics Corporation**

URL: http://www.ncsd.necel.com/

▶ For further information, please contact